

# **BONDCHECK**

PITCH-CATCH, RESONANCE, MIA BOND TESTING MODES



- Multi-mode Bond Testing instrument.
- · Unique calibration function for fast and easy set-up.
- · Lightweight and portable.
- · Dry coupled pitch-catch and MIA probes.
- · Automatic Test Frequency Optimisation.
- Ideal for inspection on metallic bonded structures, composite and metallic honeycomb.
- Two year warranty.



# Large, daylight readable, configurable colour screen.

The BONDCHECK has a large 14.5cm (5.7 Inches) LCD Colour Screen of 640 x 480 pixels providing the operator with excellent signal resolution and presentation together with the choice of configuring their own colour schemes and display types.

It is easy to optimise the screen presentation regardless of the lighting conditions. A secondary pane can be configured to create a split screen display or an inset window, with a choice of X-Y spot, frequency sweep, RF waveform and Spectrum displays.

The BONDCHECK is a multi-mode bond testing flaw detector. It provides high speed inspection in pitch-catch, resonance and MIA bond testing modes, with excellent defect sensitivity.

All functions are housed in a single lightweight instrument with a common user interface between the three modes, delivering a simple and intuitive operator led set up. A great all round asset for inspection in the laboratory or under cover as well as out in the field.

### Easy to use menus and icon system.

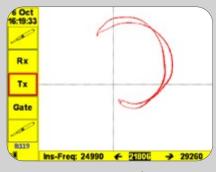
The BONDCHECK menu system is simple and fast to navigate. It has the ability to add individually selectable soft key menu items to the sidebar for rapid function access and a "quick-setting menu" for easy set-up, review and adjustment.

With four operator selectable soft keys and a fifth slot for the last menu function used, technicians can quickly modify the system with their preferences. Each saved instrument setting can be associated with a unique, single press set of quick access soft keys. There are also two front panel hard keys that can be readily programmed for rapid single press access to frequently used functions.

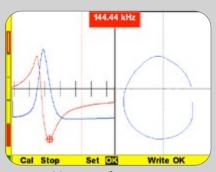
## ACCURATE, CLEAR AND SIMPLE BOND TESTING INSPECTION.



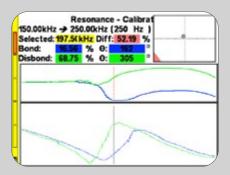
Bond Test Mode Menu System



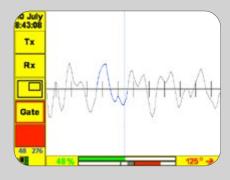
Sweep Mode



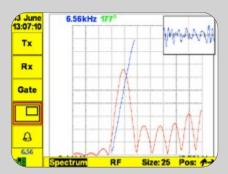
Air calibration for Resonance mode probes.



MIA mode calibration showing bond and dis-bond,



MIA mode inspection phase alarm.



Spectrum view with phase, and RF waveform inset window.

#### PITCH-CATCH PROBE

Ergonomically designed and manufactured from CNC machined Aluminium with rubber hand grips, the BONDCHECK Pitch-Catch probe is both comfortable to use and robust; whilst offering the best in performance and durability.

The probe feet can be positioned by the user to suit the inspection task, and the hard wearing probe tips are interchangeable with rounded and flat tip profiles available. The probe is broad band and is suitable for a wide range of applications.

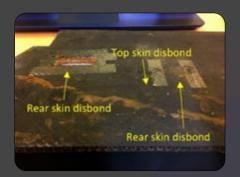
The stainless steel transmit and receive sensors are positioned close to the edge of the housing, and a smaller probe form factor is also available to allow inspection in tight areas. An alarm LED on the probe can be triggered from the BONDCHECK alarm settings. The probe incorporates a digital ID which stores its serial number together with programmable settings.

Pitch Catch Probe Specification				
Operating Frequencies	30kHz (suitable for 10kHz to 50kHz operation)			
Transmit - receive probe separation	17mm			
Transmit - receive probe linear travel	>5mm			
Probe auto-recognition	Yes			
Probe alarm LED	Yes			
Probe feet	Multiple positions, user changeable.			
Probe tips	Rounded end and flat end, replaceable by user.			
Probe materials	Anodised aluminium case, with stainless steel probe housings, rubber finger grip.			
Probe connector	LEMO:ECG.1B.308.CLV			
One-wire integrated memory for serial number and settings.				

# Pitch-Catch Probe Application

## Thin Fibre Honeycomb with CFRP skin sample Rear Disbonds

The BONDCHECK calibration function was used to find an inspection frequency to detect a 60mm x 25mm rectangular, and 15mm diameter circular core to rear skin disbond (simulated by removal of the rear skin ). Setting the inspection range to the maximum from 1kHz to 50kHz and the step frequency to 100Hz, the following bond and disbond spectra are obtained, with 34.2kHz determined as the optimum inspection frequency with other potential frequencies of interest around 20kHz.



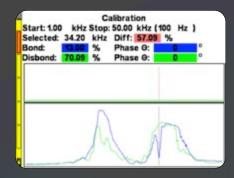
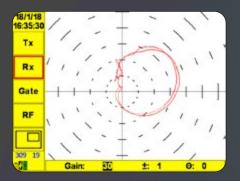


Figure 3: Thin CFRP honeycomb sample with rear surface disbonds.

In RF mode, a difference of ~10% at best is observed at either frequency between the bonded and dis-bonded areas. A swept frequency inspection was configured from 15kHz to 32kHz, responses from the disbonded and bonded rear skin shown below provide a much clearer difference.



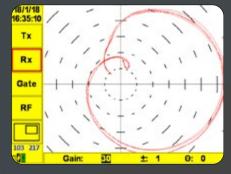


Figure 4: BondCheck frequency sweep response from bonded (left) and disbonded (right) rear surface CFRP skin to 10mm fibre honeycomb core. Rectangular defect 60x25mm.



#### **RESONANCE PROBES**

Now available in a number of frequencies (75, 90, 165, 200, 250 and 330kHz) which can be supplied as a 6 probe kit or individually. Ergonomically designed, they can be connected to the instrument using the same cable as the Pitch-Catch probes.

The stainless steel probe with tough polymer hand grip and Alumina wear face provide robust performance. Like all BondCheck probes the Alarm LED and digital ID allow ease of use and for serial number and settings to be stored. The BONDCHECK allows an air calibration to be carried out to determine most sensitive inspection frequency.





Resonance Probe Specification		
Operating Frequencies	75kHz. 90kHz, 165kHz, 200kHz, 250kHz, 330kHz	
Transducer face φ	15mm for >150kHz 23mm <150kHz	
Probe Auto-recognition	Yes	
Probe alarm LED	Yes	
Probe material	Polymer handgrip, Stainless Steel probe, with alumina wearface	
Probe connector	LEMO:ECG.1B.308.CLV	
One-wire integrated mem	nory for storing serial number,	

### **Resonance Mode**

Resonance mode is ideal for inspection of bonded aluminium lap joints commonly found in aerospace structures such as wing and aileron stiffeners, and has good penetration through multi-layered structures and adhesive bond lines. Resonance probes are narrow band with high Q, and are particularly sensitive at their natural resonant frequency. Once the resonance probe is ultrasonically coupled to the structure under test, the impedance spectrum of the probe is modified by the acoustic impedance and geometry of the bonded structure, which allows dis-bonds between layers to be identified.

The bond-line resonant frequency increases in the event of a partial bond, and substantially in the case of a complete dis-bond. Probe frequencies are selected to provide optimum sensitivity to the structure under test, and the range of 6 probes covers the requirements of most applications, although specific frequencies can be accommodated on request.

Application	Pitch-Catch	Resonance	MIA
Carbon honeycomb near surface delamination	Excellent	-	Good
Carbon honeycomb core crush/cut damage	Good	-	Poor
Carbon honeycomb rear surface delamination	Good	-	-
Metallic honeycomb skin disbond / core damage	Good	-	Excellent
Metal bonded lap joint	Good	Excellent	Good
CFRP delamination	OK	Good	Good
Small defect detection	OK	Good	Good
Dry coupling	Yes	No	Yes

#### **MIA PROBES**

The MIA technique is particularly useful for small defect detection, using a dry coupled probe with a small contact area. The technique offers excellent near surface defect sensitivity and is particularly suitable for top surface skin to core dis-bond detection for composite as well as metallic honeycomb structures.

With the same ergonomic design features of the pitch-catch and resonance probes, the MIA probe provides a detachable foot, replaceable springs and an adjustable spring pre-load. MIA probes can be connected to the instrument using the same cable as the Pitch-Catch probes.

Software features included in the BONDCHECK instrument are tailored towards the MIA inspection technique with easy calibration and inspection tools to allow the operator to evaluate the phase response of the test material.

The BONDCHECK instrument offers MIA mode in both tone burst and continuous wave options. Thanks to the unique differential probe drive and screened probe tip, signal interference from metallic components is eliminated.



MIA Probe Specification				
Operating Frequencies	perating Frequencies 2kHz to 10kHz			
Probe auto-recognition	Yes			
Probe alarm LED	Yes			
Probe housing material	Polymer			
Probe connector LEMO:ECG.1B.308.CLV				
One-wire integrated memory for serial number and user settings.				

## **MIA Mode**

The MIA technique is sensitive to changes in near surface mechanical stiffness, and is ideally suited to composite and metallic honeycomb skin to core dis-bond detection. It offers potentially smaller defect detection than the Pitch-Catch method, better defect location and extent determination, and unlike resonance mode is dry coupled. MIA mode is also effective for bonded lap joints but limited in effectiveness to the first bond layer.

In the example shown above, dis-bonds between the Titanium honeycomb core and skin create local variations in the mechanical stiffness of the structure. The BondCheck calibration functions allow quick determination of the best inspection frequency to use for dis-bond detection, and poorly bonded areas can be quickly identified and mapped out. The curved surface geometry of the component also makes MIA mode an ideal choice, with a very small dry coupled probe contact area that is tolerant of probe orientation.



Type   5.7" (145mm), 18 bit Colour, Caylight reactable.	BONDCHECK	Specification				
Colour Schemes   User configurable Dark, Bright and Black & White.		Туре	5.7" (145mm), 18 bit Colour, daylight read	dable.		
Configurable Screen   Full Screen, Single, Dual Pane with variable size and location and function e.g. XY, Timebase.		Viewable Area	115.2mm (Horizontal) x 86.4mm (Vertical	l). Resolution 640 x 480 pixels		
Display Modes   Pitch-Catch, Resonance & MIA: Spot and Sweep modes. RF Timebase for Pitch-Catch only.		Colour Schemes	User configurable Dark, Bright and Black	& White.		
Display Modes	Diamlan	Configurable Screen	Full Screen, Single, Dual Pane with varia	Full Screen, Single, Dual Pane with variable size and location and function e.g. XY, Timebase.		
Offset Filip Manual or automatic screen orientation change to enable left or right handed use.  Operating Mode Pitch-Catch, Resonance and MIA. Output Frequency Range Pitch Catch skritz to 50kHz. Resonance: 50kHz to 50kHz but 10kHz Pitch-Catch shreep: 3 ranges: 12, 24, 38V pk-pk Pitch-Catch shreep: 3 ranges: 12, 24, 38V pk-pk Resonance: 3 ranges: 12, 24, 38V pk-pk MIA: 3 ranges: 12, 24, 38V pk-pk (high voltage drive in probe)  300 Ohms Tone burst with rectangular or hanning window with chirp. Transmit waveform points maximum: 8192 Waveform Type: Pitch-Catch/MIA Frequency Sweep: Frequency range 5kHz to 50kHz / 2kHz to 10kHz Frequency Sweep: Frequency range 5kHz to 50kHz / 2kHz to 10kHz Frequency Sweep: Frequency range 5kHz to 50kHz / 2kHz to 10kHz Sample 8tt depth: 12 bit Sample 8tt depth: 12 bit Sample 1td opthics: 40dBt Receive bandwidth: 5kHz to 100kHz - 6dB points Input voltage saturation: 4400mV Time base range: 100 to 10 ms/22ms Cross Talk: 340dB isolation Dynamic Range: 30 to 60dB. Receive bandwidth: 5kHz to 100kHz - 6dB points Fittering Fittering Fittering Fittering Acquisition Gate in RF Mode Algustable gate start, with an direshold. Algustable gate start, with and threshold. Algustable gate start, with an direshold. Algustable gate start, with and threshold. Algustable gate start, with and threshold. Algustable gate start, with an direshold and sic-bonded areas. Automatic inspection frequency determination with manual adjustment. Air calibration for resonance mode Software Micro SD up to 3268, holding over 10,000 serten shots	ыѕріау	Display Modes				
Filip		Graticules	None, Grid (4 sizes 5, 10, 15 and 20% F			
Operating Mode Output Frequency Range Pitch-Catch, Resonance and MIA. Output Frequency Range Pitch-Catch sweep: 3 ranges: 12, 24, 36V pk-pk. Pitch-Catch sweep: 3 ranges: 12, 24, 36V pk-pk. Pitch-Catch sweep: 3 ranges: 12, 24, 36V pk-pk Resonance: 3 ran		Offset				
Output Frequency Range  Pitch-Catch tone burst: 10 ranges: 1.3,6,8.10,12.18,24,30,36V pk-pk.  Pitch-Catch tone burst: 10 ranges: 1.2, 24, 36V pk-pk  Resonance: 3 ranges: 12, 24, 36V pk-pk  Minimum Output drive load impedance  Minimum Output drive load impedance  Minimum Output drive load impedance  Moverform Type: Pitch-Catch/MIA  Waveform Type: Pitch-Catch/MIA  Waveform Type: Pitch-Catch/MIA  Waveform Type: Resonance  Waveform Type: Resonance  Pitch-Catch / MIA Tone Burst  Pitch-Catch / MIA Tone Burst  Receive  Receive  Resonance & Pitch-Catch / MIA Tone Burst  Frequency range 5kHz to 500 kHz  Sample 3 ranges: 12 but  Sample 3 range: 10 range; 2 ranges  Receive  Receive bandwidth: 5kHz to 100kHz - 6dB points  Input voltage saturation: ±400mV  Time base delay: 0µs to 1ms  Cross Talk: >40dB isolation  Amplitude/phase extraction cursor: position resolution <5µs /1  Fixed Hardware Low-pass filters for Pitch-Catch for optimum amplifier SNR.  Configurable Software High-pass and Low-pass filters for Pitch-Catch for colimum amplifier SNR.  Calibration Mode  Adjustable gale start, with and threshold.  Alarm Gate in Y-T Mode  Multiple box, circle and sector alarm zones.  Performs frequency sweep of bond and dis-bonded areas.  Automatic inspection frequency oteremination with manual adjustment.  Air calibration for resonance mode  Software  Setup Storage  Setup Storage  micro SD up to 326B, holding over 10,000 serien shots		Flip	Manual or automatic screen orientation of			
Pitch-Catch tone burst: 10 ranges: 1,3,6,8,10,12,18,24,30,36V pk-pk.  Pitch-Catch sweep: 3 ranges: 12, 24, 36V pk-pk Resonance: 3 ranges: 12, 24, 36V pk-pk Milk-3 ra		Operating Mode	Pitch-Catch, Resonance and MIA.			
Pitch-Catch sweep: 3 ranges: 12, 24, 36V pk-pk Resonance: 3 ranges: 12, 24, 36V pk-pk MIA: 3 ranges: 12, 24, 36V pk-pk MIA: 3 ranges: 12, 24, 36V pk-pk (high voltage drive in probe)  30 Ohms  Transmit  Minimum Output drive load impedance:  Waveform Type: Pitch-Catch/MIA  Waveform Type: Pitch-Catch/MIA  Waveform Type: Resonance  Waveform Type: Resonance  Frequency Sweep: Frequency range 5kHz to 50kHz / 2kHz to 10kHz Sample 3kHz to 500 kHz Sample 3kHz to 500 kHz Sample Bit depth: 12 bit Gain range: 0 to 60dB Receive bandwidth: 5kHz to 100kHz - 6dB points Input voltage saturation: 2400mV Time base range: 100µs to 2ms/2zms Time base delay: 0µs to 1ms Cross Talk: >40dB isolation Dynamic Range: >150dB Bit depth: 24 bit Resonance & Pitch-Catch Sweep  Fixed Hardware Low-pass filters 100kHz Amplitude/phase extraction cursor: position resolution <\$\sigma \text{y} 1/4 Amplitude/phase extraction to reduce surface scanning noise. Fixed Hardware High-pass after for Pitch-Catch to reduce surface scanning noise. Fixed Hardware High-pass filters 100kHz for Pitch-Catch for optimum amplifier SNR. Configurable Software High-pass after for Pitch-Catch for educe surface scanning noise. Fixed Hardware High-pass after sof NokHz for Pitch-Catch for optimum amplifier SNR. Configurable Software High-pass and Low-pass filters for all modes Adjustable gate start, width and threshold. Alarm Gate in Y-T Mode Multiple box, circle and sector alarm zones. Automatic inspection frequency sweep of bond and dis-bonded areas. Automatic inspection frequency determination with manual adjustment. Air calibration for resonance mode Status no screen and probe LED.  Removable Datas Storage Stor		Output Frequency Range	Pitch Catch: 5kHz to 50kHz.	Pitch Catch: 5kHz to 50kHz. Resonance: 50kHz to 500kHz MIA: 2kHz to 10kHz		
Resonance: 3 ranges: 12, 24, 36V pk-pk			Pitch-Catch tone burst: 10 ranges: 1,3,6,	8,10,12,18,24,30,36V pk-pk.		
Resonance 3 ranges: 12, 24, 36V pk-pk MIA: 3 ranges: 12, 24, 36V pk-pk (high voltage drive in probe)  Minimum Output drive load impedance  Waveform Type: Pitch-Catch/MIA  Waveform Type: Pitch-Catch/MIA  Waveform Type: Resonance  Waveform Type: Resonance  Frequency Sweep: Frequency range 5kHz to 50kHz / 2kHz to 10kHz  Fixed or swept waveform  Frequency range 5kHz to 50kHz / 2kHz to 10kHz  Sample rate: 440kHz / 100kHz  Sample Rid deght: 12 bit Gain range: 0 to 60dB  Receive bandwidth: 5kHz to 100kHz - 6dB points  Input voltage saturation: 4400mV  Time base range: 100µs to 2ms / 2zms  Cross Talk: >40dB isolation Amplitude/phase extraction cursor: position resolution <5µs / 1  Dynamic Range: -150dB  Bit depth: 24 bit  Gain range: 0 to 60dB.  Receive bandwidth: DC to 20MHz  Amplitude/phase extraction by QAM demodulation  Fixed Hardware High-pass filter for Pitch-Catch to reduce surface scanning noise.  Fixed Hardware Low-pass filters 100kHz for Pitch-Catch for optimum amplifier SNR.  Configurable Software High-pass and Low-pass filters of all modes  Adjustable gate start, width and threshold.  Alarm Gate in Y-T Mode  Multiple box, circle and sector alarm zones.  Partomate  Software  Calibration Mode  Status on screen and probe LED.  Removable  Data  Storage  Storage  Micro SD up to 326B, holding over 10,000 settings  micro SD up to 326B, holding over 10,000 settings  micro SD up to 326B, holding over 10,000 settings  micro SD up to 326B, holding over 10,000 settings  micro SD up to 326B, holding over 10,000 settings		0.1.11/1.	Pitch-Catch sweep: 3 ranges: 12, 24, 36	V pk-pk		
Minimum Output drive load impedance   300 Ohms   Tone burst with rectangular or hanning window with chirp.   Transmit waveform points maximum: 8192   Waveform Type: Pitch-Catch/MIA   Waveform Type: Resonance   Frequency Sweep: Frequency range 5kHz to 500kHz / 2kHz to 10kHz   Frequency Sweep: Frequency range 5kHz to 500kHz / 2kHz to 10kHz   Frequency range 5kHz to 500kHz / 2kHz to 10kHz   Sample rate: 440kHz / 100kHz   Maximum PRF: 14Hz   Sample rate: 440kHz / 100kHz   Maximum PRF: 14Hz   Sample Bit depth: 12 bit   Gain range: 0 to 60dB   Receive bandwidth: 5kHz to 100kHz - 6dB points   Input voltage saturation: ±400mV   Time base range: 100µs to 2ms/ 22ms   Time base delay: 0µs to 1ms   Cross Talk: >400B isolation   Amplitude/phase extraction cursor: position resolution <5µs / 1   Dynamic Range: >150dB   Bit depth: 24 bit   Gain Range: >30 to 60dB.   Receive bandwidth: DC to 20MHz   Amplitude/phase extraction cursor: position resolution <5µs / 1   Amplitude/phase extraction by QAM demodulation   Fixed Hardware High-pass filter for Pitch-Catch to reduce surface scanning noise.   Fixed Hardware High-pass and Low-pass filters for all modes   Adjustable gate start, width and threshold.   Alarm Gate in Y-T Mode   Adjustable gate start, width and threshold.   Alarm Gate in Y-T Mode   Adjustable gate start, width and threshold.   Alarm Gate in Y-T Mode   Adjustable gate start, width and threshold.   Alarm Gate in Y-T Mode   Performs frequency sweep of bond and dis-bonded areas.   Automatic inspection frequency determination with manual adjustment.   Ali calibration for resonance mode   Bond/Dis-bond Alarm   Status on screen and probe LED.   Stored Screen Shots   Micro SD up to 326B, holding over 10,000 settings   Stored Screen Shots   Micro SD up to 326B, holding over 10,000 settings   Stored Screen Shots   Sicred Screen		Output voltage	Resonance: 3 ranges: 12, 24, 36V pk-pk			
Tone burst with rectangular or hanning window with chirp.   Transmit waveform points maximum: 8192			MIA: 3 ranges: 12, 24, 36Vpk-pk (high vo	oltage drive in probe)		
Waveform Type: Pitch-Catch/MIA  Waveform Type: Resonance  Waveform Type: Resonance  Waveform Type: Resonance  Frequency Sweep: Frequency range 5kHz to 50kHz / 2kHz to 10kHz Fixed or swept waveform Frequency range 5kHz to 50kHz / 2kHz to 10kHz Fixed or swept waveform Frequency range 5kHz to 50kHz  Sample rate: 440kHz / 100kHz Sample Bit depth: 12 bit Receive Bit depth: 12 bit Receive July voltage saturation: ±400kHz  Gain range: 0 to 60dB Receive July voltage saturation: ±400mV Time base range: 100µs to 2ms/ 2zms Time base delay: 0µs to 1ms Cross Talk: >40dB Isolation Amplitude/phase extraction cursor: position resolution <5µs /1 Dynamic Range: >150dB Bit depth: 24 bit Gain Range: >30 to 60dB. Receive bandwidth: DC to 20MHz Amplitude/phase extraction by QAM demodulation Fixed Hardware Low-pass filter for Pitch-Catch for optimum amplifier SNR. Configurable Software High-pass and Low-pass filters for all modes Adjustable gate start, width and threshold.  Alarm Gate in Y-T Mode Adjustable gate start, width and threshold.  Alarm Gate in Y-T Mode Bond/Dis-bond Alarm Status on screen and probe LED.  Removable Data Storands Sto	Transmit	Minimum Output drive load impeda	nce 300 Ohms			
Waveform Type: Pitch-Catch/MIA  Waveform duration: Maximum 3.2ms / 2.5ms  Waveform output DAC clock rate: 2.5MHz fixed  Frequency Sweep: Frequency range 5kHz to 50kHz / 2kHz to 10kHz  Fixed or swept waveform  Frequency range 5kHz to 500 kHz  Sample rate: 440kHz / 100kHz  Maximum PRF: 14Hz  Sample Bit depth: 12 bit Gain range: 0 to 60dB  Receive bandwidth: 5kHz to 100kHz-6dB points Input voltage saturation: ±400mV  Time base range: 100µs to 2ms/ 22ms  Cross Talk: >40dB Isolation Amplitude/phase extraction cursor: position resolution <5µs /1  Dynamic Range: >150dB  Bit depth: 24 bit Gain Range: >0 to 60dB.  Receive bandwidth: DC to 20MHz  Amplitude/phase extraction by QAM demodulation  Fixed Hardware High-pass filter for Pitch-Catch to reduce surface scanning noise.  Fixed Hardware High-pass filter for Pitch-Catch for optimum amplifier SNR.  Configurable Software High-pass and Low-pass filters for all modes  Adjustable gate start, width and threshold.  Alarm Gate in Y-T Mode Multiple box, circle and sector alarm zones.  Performs frequency sweep of bond and dis-bonded areas.  Automatic inspection frequency determination with manual adjustment.  Air calibration for resonance mode  Bond/Dis-bond Alarm Status on screen and probe LED.  Removable  Data  Storage  Stored Screen Shots  Waveform output DAC clock rate: 2.5MHz bothz  Frequency sweep Frequency range fisher to 50kHz / 2kHz to 10kHz  Maximum PRF: 14Hz  Gain range: 0 to 60dB  Receive bandwidth: 5kHz to 100kHz - 6dB points  Imput voltage saturation: \$40mV  Time base delay: 0µs to 1ms  Amplitude/phase extraction cursor: position resolution <5ps /1  Fitted Hardware High-pass filter for Pitch-Catch for optimum amplifier SNR.  Configurable Software High-pass and Low-pass filters for all modes  Adjustable gate start, width and threshold.  Alarm Gate in Y-T Mode  Bond/Dis-bond Alarm  Status on screen and probe LED.  Removable  Pata  Storage  Fitter Gain range: 0 to 60dB  Receive			Tone burst with rectangular or hanning w	indow with chirp.		
Waveform duration: Maximum 3.2ms / 2.5ms   Waveform output DAC clock rate: 2.5MHz fixed   Frequency Sweep: Frequency range 5kHz to 500 kHz   Fixed or swept waveform   Frequency range 5kHz to 500 kHz   Sample rate: 440kHz / 100kHz   Maximum PRF: 14Hz   Sample rate: 440kHz / 100kHz   Maximum PRF: 14Hz   Sample slit depth: 12 bit   Gain range: 0 to 60dB   Receive bandwidth: 5kHz to 100kHz-6dB points   Input voltage saturation: 2400mV   Time base range: 100µs to 2ms/ 22ms   Time base delay: 0µs to 1ms   Cross Talk: >40dB isolation   Amplitude/phase extraction cursor: position resolution <5µs / 1   Dynamic Range: >150dB   Bit depth: 24 bit   Amplitude/phase extraction cursor: position resolution <5µs / 1   Receive bandwidth: DC to 20MHz   Amplitude/phase extraction by QAM demodulation   Fixed Hardware High-pass filter for Pitch-Catch to reduce surface scanning noise. Fixed Hardware High-pass filter for Pitch-Catch for optimum amplifier SNR. Configurable Software High-pass and Low-pass filters for all modes   Adarm Gate in Y-T Mode   Adjustable gate start, width and threshold. Alarm Gate in Y-T Mode   Performs frequency sweep of bond and dis-bonded areas. Automatic inspection frequency determination with manual adjustment. Air calibration for resonance mode   Bond/Dis-bond Alarm   Status on screen and probe LED.  Removable   Data   Storage   Stored Screen Shots   micro SD up to 32GB, holding over 10,000 screen shots			Transmit waveform points maximum: 819	92		
Fixed or swept waveform   Frequency range 5kHz to 500 kHz   Sample rate: 440kHz / 100kHz   Maximum PRF: 14Hz   Sample rate: 440kHz / 100kHz   Sample rate: 440kHz / 100kHz   Gain range: 0 to 60dB   Receive bandwidth: 5kHz to 100kHz -6dB points   Input voltage saturation: ±400mV   Time base range: 100µs to 2ms/ 22ms   Time base delay: 0µs to 1ms   Cross Talk: >40dB isolation   Amplitude/phase extraction cursor: position resolution <5µs /1   Dynamic Range: >150dB   Bit depth: 24 bit   Gain Range: >30 to 60dB.   Receive bandwidth: DC to 20MHz   Amplitude/phase extraction by QAM demodulation   Fixed Hardware High-pass filter for Pitch-Catch for optimum amplifier SNR.   Configurable Software High-pass and Low-pass filters for all modes   Adjustable gate start, width and threshold.   Alarm Gate in Y-T Mode   Multiple box, circle and sector alarm zones.   Performs frequency sweep of bond and dis-bonded areas.   Automatic inspection frequency determination with manual adjustment.   Air calibration for resonance mode   Bond/Dis-bond Alarm   Status on screen and probe LED.   Setup Storage   micro SD up to 32GB, holding over 10,000 settings   Storage   micro SD up to 32GB, holding over 10,000 sertens shots   Micro SD up to 32GB, holding over 10,000 screen shots   Micro SD up to 32GB, holding over 10,000 screen shots   Micro SD up to 32GB, holding over 10,000 screen shots   Micro SD up to 32GB, holding over 10,000 screen shots   Micro SD up to 32GB, holding over 10,000 screen shots   Micro SD up to 32GB, holding over 10,000 screen shots   Micro SD up to 32GB, holding over 10,000 screen shots   Micro SD up to 32GB, holding over 10,000 screen shots   Micro SD up to 32GB, holding over 10,000 screen shots   Micro SD up to 32GB, holding over 10,000 screen shots   Micro SD up to 32GB, h		Waveform Type: Pitch-Catch/MIA	Waveform duration: Maximum 3.2ms / 2.	5ms Waveform output DAC clock rate: 2.5MHz fixed		
Pitch-Catch / MIA Tone Burst   Sample rate: 440kHz / 100kHz   Sample rate: 440kHz / 100kHz   Sample rate: 440kHz / 100kHz   Sample Bit depth: 12 bit   Gain range: 0 to 60dB			Frequency Sweep: Frequency range 5kl	Hz to 50kHz / 2kHz to 10kHz		
Pitch-Catch / MIA Tone Burst  Pitch-Catch / MIA Tone Burst  Pitch-Catch / MIA Tone Burst  Receive  Resonance & Pitch-Catch Sweep  Resonance & Pitch-Catch Sweep  Filtering  Acquisition Gate in RF Mode Algustable gate start, width and threshold.  Acquisition Gate in RF Mode Algustable gate start, width and threshold.  Acquisition Mode  Acquisition Mode  Acquisition Mode  Bond/Dis-bond Alarm  Setup Storage  Removable Data Storage  Pitch-Catch Shore  Sample Ret 440kHz / 100kHz   Maximum PRF: 14Hz   Gain range: 0 to 60dB   Receive bandwidth: 5kHz to 100kHz -6dB points   Input voltage saturation: ±400mV   Time base range: 100µs to 2ms/ 22ms   Time base delay: 0µs to 1ms   Amplitude/phase extraction cursor: position resolution <5µs /1   Dynamic Range: >150dB   Bit depth: 24 bit   Gain Range: >30 to 60dB. Receive bandwidth: DC to 20MHz   Amplitude/phase extraction by QAM demodulation   Fixed Hardware High-pass filter for Pitch-Catch to reduce surface scanning noise. Fixed Hardware Low-pass filters 100kHz for Pitch-Catch for optimum amplifier SNR. Configurable Software High-pass and Low-pass filters for all modes   Adjustable gate start, width and threshold.  Alarm Gate in Y-T Mode   Multiple box, circle and sector alarm zones.  Performs frequency sweep of bond and dis-bonded areas. Automatic inspection frequency determination with manual adjustment. Air calibration for resonance mode   Setup Storage   Micro SD up to 32GB, holding over 10,000 settings   Storage   Storage			Fixed or swept waveform			
Pitch-Catch / MIA Tone Burst    Pitch-Catch / MIA Tone Burst   Receive bandwidth: 5kHz to 100kHz -6dB points   Input voltage saturation: ±400mV   Time base range: 100µs to 2ms/ 22ms   Time base delay: 0µs to 1ms   Cross Talk: >40dB isolation   Amplitude/phase extraction cursor: position resolution <5µs /1		Waveform Type: Resonance	Frequency range 5kHz to 500 kHz			
Receive bandwidth: 5kHz to 100kHz -6dB points Input voltage saturation: ±400mV Time base range: 100µs to 2ms/ 22ms Time base delay: 0µs to 1ms Cross Talk: >40dB isolation Amplitude/phase extraction cursor: position resolution <5µs /1 Dynamic Range: >150dB Bit depth: 24 bit Gain Range: -30 to 60dB. Receive bandwidth: DC to 20MHz Amplitude/phase extraction by QAM demodulation Fixed Hardware High-pass filter for Pitch-Catch for optimum amplifier SNR. Configurable Software High-pass and Low-pass filters for all modes Adjustable gate start, width and threshold. Alarm Gate in Y-T Mode Multiple box, circle and sector alarm zones. Performs frequency sweep of bond and dis-bonded areas. Automatic inspection frequency determination with manual adjustment. Air calibration for resonance mode Bond/Dis-bond Alarm Storage  Removable Data Storage Storage  Receive bandwidth: 5kHz to 100kHz for Pitch-Catch for optimum amplifier SNR. Configurable Software High-pass and Low-pass filters for all modes Adjustable gate start, width and threshold. Adjustable gate start, width and threshold. Adjustable gate start, width and threshold. Alarm Gate in Y-T Mode Multiple box, circle and sector alarm zones. Performs frequency determination with manual adjustment. Air calibration for resonance mode  Bond/Dis-bond Alarm Storage Storage Storage Micro SD up to 32GB, holding over 10,000 settings Storage Storage Micro SD up to 32GB, holding over 10,000 screen shots			Sample rate: 440kHz / 100kHz	Maximum PRF: 14Hz		
Pitch-Catch / MIA Tone Burst   Input voltage saturation: ±400mV   Time base range: 100µs to 2ms/ 22ms   Time base delay: 0µs to 1ms			Sample Bit depth: 12 bit	Gain range: 0 to 60dB		
Input voltage saturation: ±400mV   Time base range: 100µs to 2ms/ 22ms   Time base delay: 0µs to 1ms			Receive bandwidth: 5kHz to 100kHz -6dl	B points		
Receive  Resonance & Pitch-Catch Sweep  Receive bandwidth: DC to 20MHz  Amplitude/phase extraction by QAM demodulation  Fixed Hardware High-pass filter for Pitch-Catch to reduce surface scanning noise.  Fixed Hardware Low-pass filters 100kHz for Pitch-Catch for optimum amplifier SNR.  Configurable Software High-pass and Low-pass filters for all modes  Acquisition Gate in RF Mode  Algustable gate start, width and threshold.  Alarm Gate in Y-T Mode  Multiple box, circle and sector alarm zones.  Performs frequency sweep of bond and dis-bonded areas.  Automatic inspection frequency determination with manual adjustment.  Air calibration for resonance mode  Status on screen and probe LED.  Removable  Data  Storage  Stored Screen Shots  micro SD up to 32GB, holding over 10,000 screen shots		Pitch-Catch / MIA Tone Burst	Input voltage saturation: ±400mV			
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Resonance & Pitch-Catch Sweep  Resonance & Pitch-Catch Sweep  Resonance & Pitch-Catch Sweep  Resonance & Pitch-Catch Sweep  Gain Range: -30 to 60dB.  Receive bandwidth: DC to 20MHz  Amplitude/phase extraction by QAM demodulation  Fixed Hardware High-pass filter for Pitch-Catch to reduce surface scanning noise.  Fixed Hardware Low-pass filters 100kHz for Pitch-Catch for optimum amplifier SNR.  Configurable Software High-pass and Low-pass filters for all modes  Acquisition Gate in RF Mode Adjustable gate start, width and threshold.  Alarm Gate in Y-T Mode Multiple box, circle and sector alarm zones.  Calibration Mode Performs frequency sweep of bond and dis-bonded areas. Automatic inspection frequency determination with manual adjustment. Air calibration for resonance mode  Bond/Dis-bond Alarm Status on screen and probe LED.  Removable Data Storage Stored Screen Shots  micro SD up to 32GB, holding over 10,000 screen shots  micro SD up to 32GB, holding over 10,000 screen shots			Cross Talk: >40dB isolation	Amplitude/phase extraction cursor: position resolution <5µs /10µs		
Resonance & Pitch-Catch Sweep  Resonance & Pitch-Catch Sweep  Gain Range: -30 to 60dB. Receive bandwidth: DC to 20MHz Amplitude/phase extraction by QAM demodulation  Fixed Hardware High-pass filter for Pitch-Catch to reduce surface scanning noise.  Fixed Hardware Low-pass filters 100kHz for Pitch-Catch for optimum amplifier SNR.  Configurable Software High-pass and Low-pass filters for all modes  Acquisition Gate in RF Mode Adjustable gate start, width and threshold.  Alarm Gate in Y-T Mode  Multiple box, circle and sector alarm zones.  Performs frequency sweep of bond and dis-bonded areas.  Automatic inspection frequency determination with manual adjustment.  Air calibration for resonance mode  Bond/Dis-bond Alarm  Status on screen and probe LED.  Removable Data Storage Stored Screen Shots  Bit depth: 24 bit  Gain Range: -30 to 60dB.  Removable Data Storage Stored Screen Shots  Bit depth: 24 bit  Gain Range: -30 to 60dB.  Removable Data Storage Stored Screen Shots  Bit depth: 24 bit  Gain Range: -30 to 60dB.  Removable Data Storage Stored Screen Shots  Bit depth: 24 bit  Gain Range: -30 to 60dB.  Removable Data Storage Stored Screen Shots				p and p		
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Calibration Mode  Calibration Mode  Automatic inspection frequency determination with manual adjustment. Air calibration for resonance mode  Bond/Dis-bond Alarm  Status on screen and probe LED.  Setup Storage  Storage  Storage  Storage  Storage  Calibration Mode  Automatic inspection frequency determination with manual adjustment. Air calibration for resonance mode  Status on screen and probe LED.  Setup Storage  Automatic inspection frequency determination with manual adjustment. Air calibration for resonance mode  Status on screen and probe LED.  Setup Storage		Alarm Gate in Y-T Mode				
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Data Stored Screen Shots micro SD up to 32GB, holding over 10,000 screen shots  Storage		Bond/Dis-bond Alarm	Status on screen and probe LED.			
Data Stored Screen Shots micro SD up to 32GB, holding over 10,000 screen shots  Storage	Removable	Setup Storage	micro SD up to 32GB, holding over 10,000			
Storage						
Record Replay Record Replay Real-time recording of trace data and Replay on instruments and desktop PC up to 164 seconds	Storage	Record Replay	Real-time recording of trace data and Rep			
Weight 1.2 kg, 2.7 lbs.						
Size (w x h x d) 237.5mm x 144mm x 52mm / 9.4" x 5.7" x 2.1"	Physical			-		
				Storage for up to 12 months -20 to +60 °C. Nominal +20 °C		
IP Rating 54						
Warranty 2 year Manufacturer's Warranty Covers all components of the BondCheck, excludes customer damage or misuse. (probes not included)	Warranty	-	Covers all components of the BondCheck	k excludes customer damage or misuse (probes not included)		

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